## COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled TAPE CIRCUIT SUBSTRATE HAVING WAVY BEAM LEADS AND SEMICONDUCTOR CHIP PACKAGE USING THE SAME, the specification of which:

	is attached here was filed and was amende with amendmen	as Apped on	plication No(if applicabl	le) cable).	
	state that I have review neluding the claims, as				ied
I ackno of this applicat	wledge the duty to disc ion in accordance with	lose information Title 37, Code	on which is material to of Federal Regulation	to the patentabilityons, Sec. 1.56.	у
(a)-(d) or §365 of any PCT int United States of for patent or in	velaim foreign priority (b) of any foreign appliemational application vertical below ventor's certificate, or of the application on vertical to the order.	cation(s) for payhich designated and have also for any PCT int	atent or inventor's ce ed at least one countr identified below any ernational application	ertificate, or §365( ry other than the y foreign applicat	(a)
Prior Foreign A	application(s)			Claimin Priority	_
2003-15179 (Number)		<u>rea</u>	11 March 2003 (Day/Month/Year Fi	🛛 🖂	 No
	claim the benefit under		ited States Code, Sec	:. 119(e) of any	
Provisional Ap	plication No.		Filing	g Date	
I harah	, claim the benefit unde	er Title 35 IIn			of

I hereby claim the benefit under Title 35, United States Code, Sec. 120 or §365(c) of any PCT international application designating the United States of America listed below and,

I hereby claim the benefit under Title 35, United States Code, Sec. 120 or §365(c) of any PCT international application designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application No.)	(Filing Date)	(Status) (patented, pending, abandoned

I hereby appoint the following attorneys to prosecute the application, to file a corresponding international application, to prosecute and transact all business in the Patent and Trademark Office connected therewith:

Customer No.

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PATENT TRADEMARK OFFICE

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the

United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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